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(54) VEHICULAR CAMERA MODULE

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(57)**ABSTRACT**

A vehicular camera module includes a front housing member, an imaging sensor, a lens optically aligned with the imaging sensor, a rear housing member, and a circuit board. With the circuit board accommodated within the camera housing formed by the joined front and rear housing members, the imaging sensor is closer to a first side of the circuit board than to a second side of the circuit board. The rear housing member includes an electrical plug connector having a plurality of individual electrically-conductive pins that are configured to plug into respective individual pin-receiving sockets of an electrical socket connector disposed at the second side of the circuit board. Individual electrically-conductive pins of the plurality of individual electrically-conductive pins are plugged into and make electrical-conductive contact with corresponding individual pin-receiving sockets of the plurality of individual pin-receiving sockets.

